

# TIC216A, TIC216B, TIC216D, TIC216M, TIC216N, TIC216S

## SILICON BIDIRECTIONAL TRIODE THYRISTOR

- 6 A RMS
- · Glass Passivated Wafer
- 100 V to 800 V Off-State Voltage
- Max I<sub>GT</sub> of 5 mA (Quadrants 1-3)
- Sensitive gate triacs
- Compliance to ROHS

#### **DESCRIPTION**

This device is a bidirectional triode thyristor (triac) which may be triggered from the off-state to the on-state by either polarity of gate signal with main Terminal 2 at either polarity.

### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Ratings		Value					Unit
		Α	В	D	М	S	N	
V <sub>DRM</sub>	Repetitive peak off-state voltage (see Note1)	100	200	400	600	700	800	V
I <sub>T(RMS)</sub>	Full-cycle RMS on-state current at (or below) 70°C case temperature (see note2)			А				
I <sub>TSM</sub>	Peak on-state surge current full-sine-wave (see Note3)		60					Α
I <sub>TSM</sub>	Peak on-state surge current half-sine-wave (see Note4)		70					Α
I <sub>GM</sub>	Peak gate current		± 1					Α
P <sub>GM</sub>	Peak gate power dissipation at (or below) 85°C case temperature (pulse width ≤200 µs)		2.2				W	
P <sub>G(AV)</sub>	Average gate power dissipation at (or below) 85°C case (see Note5)		0.9				W	
T <sub>C</sub>	Operating case temperature range		-40 to +110					°C
T <sub>stg</sub>	Storage temperature range		-40 to +125				°C	
TL	Lead temperature 1.6 mm from case for 10 seconds		230				°C	



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Notes:

- 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal
- 2. This value applies for 50-Hz full-sine-wave operation with resistive load. Above 70°C derate linearly to 110°C case temperature at the rate of 150 mA/°C.
- 3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge, gate control may be lost.
- 4. This value applies for one 50-Hz half-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge, gate control may be lost.
- 5. This value applies for a maximum averaging time of 20 ms.

#### THERMAL CHARACTERISTICS

Symbol	Ratings	Value	Unit	
R <sub>∂JC</sub>	Junction to case thermal resistance	≤ 2.5	°C/W	
R∂JA	Junction to free air thermal resistance	≤ 62.5	C/ VV	

### **ELECTRICAL CHARACTERISTICS**

TC=25°C unless otherwise noted

Symbol	Ratings	Test Condition(s)	Min	Тур	Mx	Unit
I <sub>DRM</sub>	Repetitive peak off- state current	$V_D$ = Rated $V_{DRM}$ , , $I_G$ = 0, $T_C$ = 110°C	-	-	±2	mA
I <sub>GT</sub>	Gate trigger current	$\begin{split} & \boxed{ V_{\text{supply}} = +12 \text{ V}^{\dagger}, \text{ R}_{\text{L}} = 10 \Omega,  t_{\text{p(g)}} = > 20 \mu\text{s} } \\ & \boxed{ V_{\text{supply}} = +12 \text{ V}^{\dagger}, \text{ R}_{\text{L}} = 10 \Omega,  t_{\text{p(g)}} = > 20 \mu\text{s} } \\ & \boxed{ V_{\text{supply}} = -12 \text{ V}^{\dagger}, \text{ R}_{\text{L}} = 10 \Omega,  t_{\text{p(g)}} = > 20 \mu\text{s} } \end{split} }$	-	-	5 -5 -5	mA
V <sub>GT</sub>	Gate trigger voltage	$\begin{split} &   V_{\text{supply}} = -12 \; V_{\uparrow}^{\dagger}, \; R_L = 10 \; \Omega, \; t_{p(g)} = > 20 \; \mu s \\ &   V_{\text{supply}} = +12 \; V_{\uparrow}^{\dagger}, \; R_L = 10 \; \Omega, \; t_{p(g)} = > 20 \; \mu s \\ &   V_{\text{supply}} = +12 \; V_{\uparrow}^{\dagger}, \; R_L = 10 \; \Omega, \; t_{p(g)} = > 20 \; \mu s \\ &   V_{\text{supply}} = -12 \; V_{\uparrow}^{\dagger}, \; R_L = 10 \; \Omega, \; t_{p(g)} = > 20 \; \mu s \\ &   V_{\text{supply}} = -12 \; V_{\uparrow}^{\dagger}, \; R_L = 10 \; \Omega, \; t_{p(g)} = > 20 \; \mu s \end{split}$	- - - -	- - -	10 2.2 -2.2 -2.2 3	V
I <sub>H</sub>	Holding current	$V_{\text{supply}}$ = +12 V†, $I_{\text{G}}$ = 0, initiating $I_{\text{TM}}$ = 100 mA	-	-	30	mA
		$V_{\text{supply}} = -12 \text{ V}^+, I_G = 0,$ initiating $I_{TM} = -100 \text{ mA}$	-	-	-30	
I <sub>L</sub>	Latching current	$V_{\text{supply}}$ = +12 V† (seeNote7) $V_{\text{supply}}$ = -12 V† (seeNote7)	-	50 -20	<u>-</u> -	mA
V <sub>TM</sub>	Peak on-state voltage	$I_{TM} = \pm 8.4 \text{ A}, I_G = 50 \text{ mA (see Note6)}$	-	-	±1.7	V
dv/dt	Critical rate of rise of off-state voltage	$V_{DRM}$ = Rated $V_{DRM}$ , $I_G$ = 0 $T_C$ = 110°C	-	±50	1	
dv/dt <sub>©</sub>	Critical rise of communication voltage	$V_{DRM}$ = Rated $V_{DRM}$ , $I_{TRM}$ = ± 8.4A $T_C$ = 70°C	±5	-	-	V/µs

<sup>†</sup> All voltages are whit respect to Main Terminal 1.

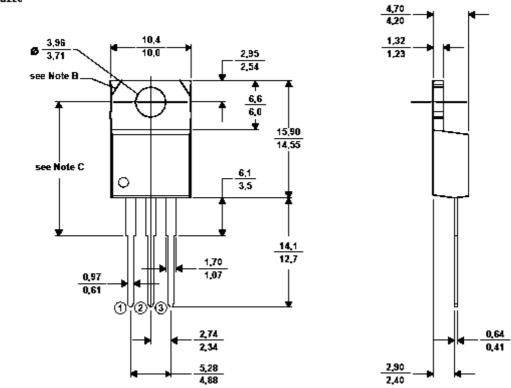


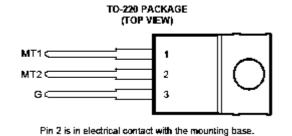
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Note 6: This parameters must be measured using pulse techniques,  $t_W = \le 1 \mu s$ , duty cycle  $\le 2$  %, voltage-sensing contacts, separate from the courrent-carrying contacts are located within 3.2mm (1/8 inch) from de device body. Note 7: The triacs are triggered by a 15-V (open circuit amplitude) pulse supplied by a generator with the following characteristics:  $R_G = 100\Omega$ ,  $t_{tp(g)} = 20 \mu s$ ,  $t_r = \le 15 ns$ ,  $t_r = 1 kHz$ .

### **MECHANICAL DATA CASE TO-220**







Pin 1 :	Main Terminal 1
Pin 2 :	Main Terminal 2
Pin 3 :	Gate